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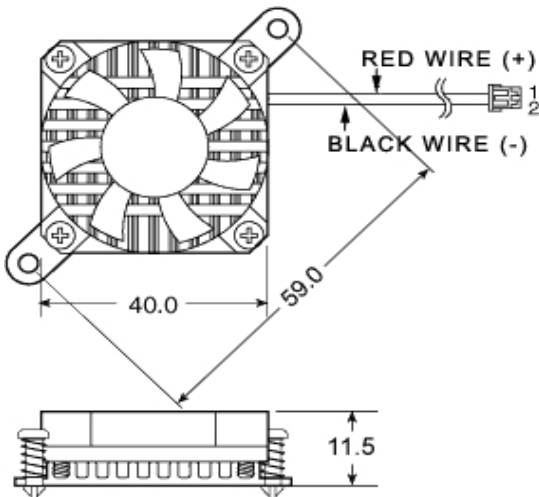
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11-5602-51

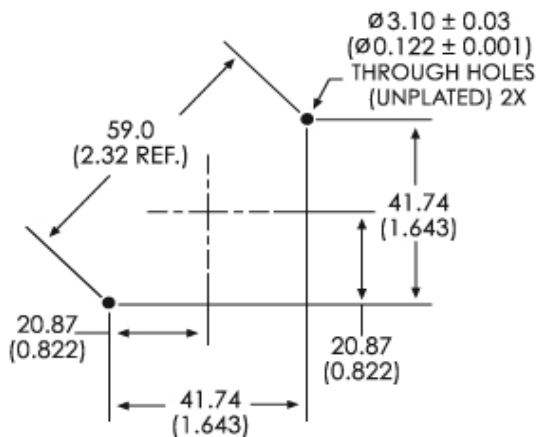


Thermal Resistance	Power Dissipation	Finish	Interface Material	Attachment
3.70 °C/W	15 W or Less	Black	Pre-applied Hi Flow Phase Change	Brass Push Pins

Mechanical Outline Drawing

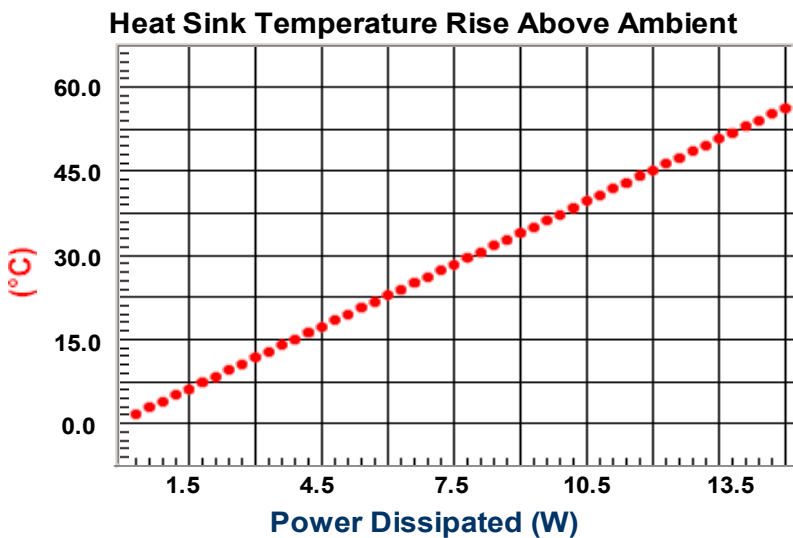


Recommended PCB Hole Pattern



Fan Size	Fan Voltage	# of Bearings	Connector Housing	Lead Length
40x40x7 mm	12 Volts	Single	Molex 2 pin (series 51021)	40 mm

Thermal Performance



The thermal resistance stated does not include the interface between the BGA and the heat sink. Due to various heat dissipation paths within a BGA device, please test the heat sink in your application.

Customizing

For different interface material, fan options, color, and attachment variation, please, contact your [local representative](#). Challenge us with your thermal requirements - we can design custom solutions.